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DERWENT-WEEK: 199910
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TITLE: Polyacetal base resin compsn. with dispersed polyolefin resin - having improved acid resistance, fusibility with polyolefin resin and mechanical properties

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PATENT-ASSIGNEE: POLYPLASTICS KK [POPL]

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PATENT-FAMILY:

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WO 9213028 A1	August 6, 1992	J
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JP 2854150 B2	February 3, 1999	N/A
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EP 522180 A1	January 13, 1993	E
013	C08J 003/20	
BR 9203917 A	June 8, 1993	N/A
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TW 236626 A	December 21, 1994	N/A
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DESIGNATED-STATES: BR CA KR US AT BE CH DE DK ES FR GB GR
IT LU MC NL SE AT BE C
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CITED-DOCUMENTS: JP 53108142; JP 60223852 ; No-Citns. ; EP 159904 ; US 4649172

APPLICATION-DATA:

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APPL-DATE		

WO 9213028A1	N/A	1992WO-JP00077
	January 28, 1992	
JP 2854150B2	N/A	1991JP-0026948
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JP 2854150B2	Previous Publ.	JP 4252232
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JP 04252232A	N/A	1991JP-0026948
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EP 522180A1	N/A	1992EP-0903747
	January 28, 1992	
EP 522180A1	N/A	1992WO-JP00077
	January 28, 1992	
EP 522180A1	Based on	WO 9213028
	N/A	
BR 9203917A	N/A	1992BR-0003917
	January 28, 1992	
BR 9203917A	N/A	1992WO-JP00077
	January 28, 1992	
BR 9203917A	Based on	WO 9213028
	N/A	
TW 236626A	N/A	1992TW-0100591
	January 28, 1992	
EP 522180A4	N/A	1992EP-0903747
	N/A	

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 C08K007/00 ;
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 C08L059/00

ABSTRACTED-PUB-NO: WO 9213028A

BASIC-ABSTRACT: Compsn. has a network structure in which components (A) and (B)

are dispersed in each other. (A) is a polyacetal resin which acts as a matrix.

(B) is a polyolefin resin. When (A) is melt mixed with (B), a filler (C) is

added in an amt. such that the relations given by equations (B) / (A+B) =

0.05-0.5 (wt.) (pref. 0.10-0.40 wt.) (1) and (C) / (B+C) = 0.1-0.7 (wt.) (2) are

satisfied. (C) has a surface tension which is at least greater than that of

(B) at the melt mixing temp. and a mean particulate dia. of 0.05-50 microns.

(B) is pref. polyethylene or a copolymer comprising polyethylene as major

component. (C) can be glass fibre, asbestos fibre, silica fibre, silica, alumina fibre, zirconia fibre, boron nitride fibre, silicon nitride fibre, B fibre, potassium titanate fibre, etc. or C black, silicate, glass beads, glass balloon, glass powder, talc, etc.. (C) can also be a resin such as aromatic polyester resin, aromatic polyamide resin, aromatic polyimide resin, polystyrene resin, acrylic resin, epoxy resin, etc..

USE/ADVANTAGE - The method is simple and is low cost. The mould obtd. from the compsn. retains the properties of polyacetal and has improved resistance against acid, fusibility with polyolefin resin and mechanical propertie

CHOSEN-DRAWING: Dwg.0/3

TITLE-TERMS:

POLYACETAL BASE RESIN COMPOSITION DISPERSE POLYOLEFIN RESIN
IMPROVE ACID
RESISTANCE FUSE POLYOLEFIN RESIN MECHANICAL PROPERTIES

DERWENT-CLASS: A17 A25

CPI-CODES: A04-G01B; A05-H03A; A07-A04E; A08-R01;

UNLINKED-DERWENT-REGISTRY-NUMBERS: 1521U; 1541U ; 1544U ;
1668U ; 1694U ; 1893U
; 5023U ; 5085U ; 5213U ; 5214U ; 5311U

POLYMER-MULTIPUNCH-CODES-AND-KEY-SERIALS:

Key Serials: 0009 0011 0016 0020 0045 0069 0072 0075 0171
0205 0218 0219 0224
0226 0232 0233 0239 0240 0304 0486 0487 1275 1282 1283 1285
1291 1511 2208 2211
2214 2215 2217 2218 2219 2220 2266 2315 2321 2332 2334 2510
2541 2545 2599 2607
2612 2617 2621 2629 2635 2662

Multipunch Codes: 014 02& 032 034 040 041 046 047 055 056
06- 07& 074 08& 080
081 09& 09- 10& 138 141 143 144 15- 151 180 20- 226 229 247
27- 305 307 308 309
310 311 314 329 364 365 392 393 394 396 437 44& 441 476 531

541 545 551 556 560
567 573 597 603 654 681 684 688 721 722 723
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CPI Secondary Accession Numbers: C1992-126618